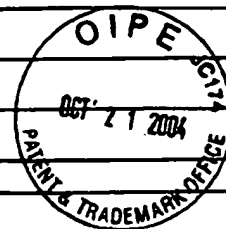


INFORMATION DISCLOSURE CITATION

Atty. Docket No.	2887.0274	Appln. No.	10/815,934
Applicant	Takyu et al.		
Filing Date	April 2, 2004	Group:	2812 2823



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Examiner Initial*	Document Number	Issue Date	Name	Class	Sub Class	Filing Date If Appropriate
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BK	2002/0048906 A1	4/25/02	Sakai et al.			
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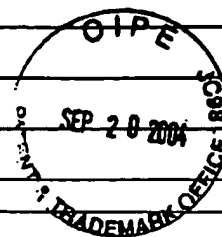
FOREIGN PATENT DOCUMENTS						
Document Number	Publication Date	Country	Class	Sub Class	Translation Yes or No	
0 981 156 A2	2/23/00	Europe				

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	European Search Report in Application No. 04008108, dated 8/5/04

Examiner	Brook Kebede	Date Considered	2/19/2005
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Atty. Docket No. 2887.0274	Appln. No. 10/815,934
Applicant Takyu et al.	
Filing Date April 2, 2004	Group: 2812J823



U.S. PATENT DOCUMENTS							
Examiner Initial*		Document Number	Issue Date	Name	Class	Sub Class	Filing Date If Appropriate

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		Document Number	Publication Date	Country	Class	Sub Class	Translation Yes or No
Bu		2003-017513	1/17/03	Japan			Abstract

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)	

Examiner Brown Kebede	Date Considered 2/19/2005
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INFORMATION DISCLOSURE CITATION

Atty. Docket No. 02887.0274	Application No. 10/815,934
Applicant Shinya TAKYU et al.	
Filing Date April 2, 2004	Group: 2823 Not assigned

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Examiner Brook Kebede	Date Considered 2/19/2005
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